

FEATURES

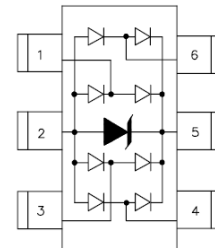
- ESD protection for high-speed data lines to
IEC 61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 8\text{kV}$ (contact)
IEC 61000-4-4 (EFT) 40A (5/50ns)
IEC 61000-4-5 (Lightning) 12A (8/20 μs)
- Array of surge rated diodes with internal TVS Diode
- Small package saves board space
- Protects four I/O lines
- Low capacitance: 3pF typical
- Low clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

SOT23-6L



APPLICATIONS

- USB 2.0 Power and Data Line Protection
- Video Graphics Cards
- Monitors and Flat Panel Displays
- Digital Video Interface (DVI)
- 10/100/1000 Ethernet
- Notebook Computers
- SIM Ports
- ATM Interfaces
- IEEE 1394 Firewire Ports



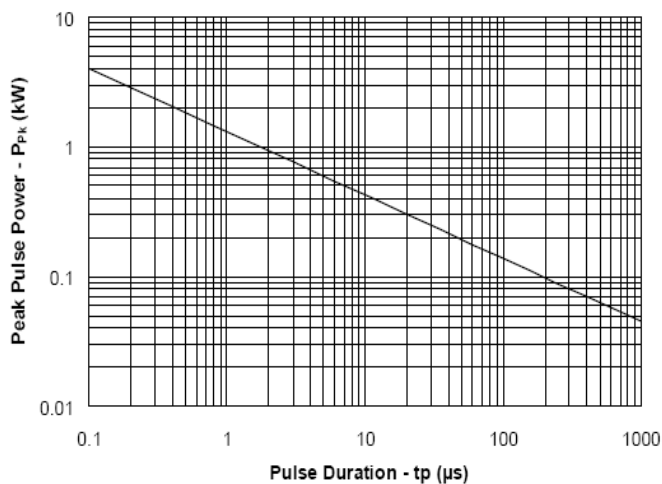
DEVICE CHARACTERISTICS

Absolute Maximum Rating			
Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20 μs)	P_{pk}	300	Watts
Peak Pulse Current (tp = 8/20 μs)	I_{pp}	12	A
ESD per IEC 61000-4-2 (Air)	V_{ESD}	15	kV
ESD per IEC 61000-4-2 (Contact)		8	
Lead Soldering Temperature	T_L	260 (10 sec.)	$^{\circ}\text{C}$
Operating Temperature	T_J	-55 to +125	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55 to +150	$^{\circ}\text{C}$

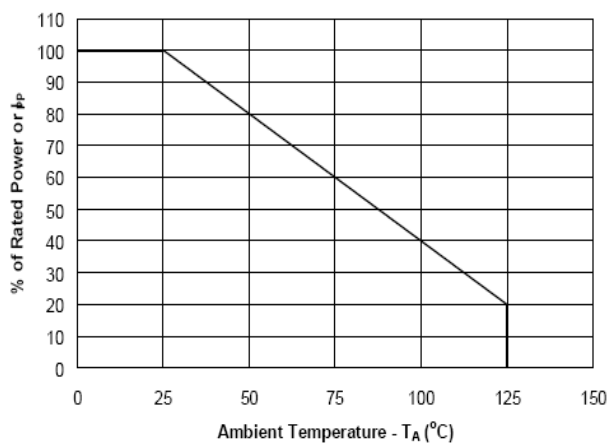
Electrical Characteristics						
SRV05-4						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}	Pin 5 to 2			5	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1\text{mA}$ Pin 5 to 2	6			V
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$, $T = 25^\circ\text{C}$ Pin 5 to 2			5	μA
Forward Voltage	V_F	$I_f = 15\text{mA}$			1.2	V
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$, $t_p = 8/20\mu\text{s}$ Any I/O pin to Ground			12.5	V
Clamping Voltage	V_C	$I_{PP} = 5\text{A}$, $t_p = 8/20\mu\text{s}$ Any I/O pin to Ground			17.5	V
Junction Capacitance	C_j	$V_R = 0\text{V}$, $f = 1\text{MHz}$ Any I/O pin to Ground		3		pF
		$V_R = 0\text{V}$, $f = 1\text{MHz}$ Between I/O pins		1.5		pF

GRAPHS

Non-Repetitive Peak Pulse Power vs. Pulse Time

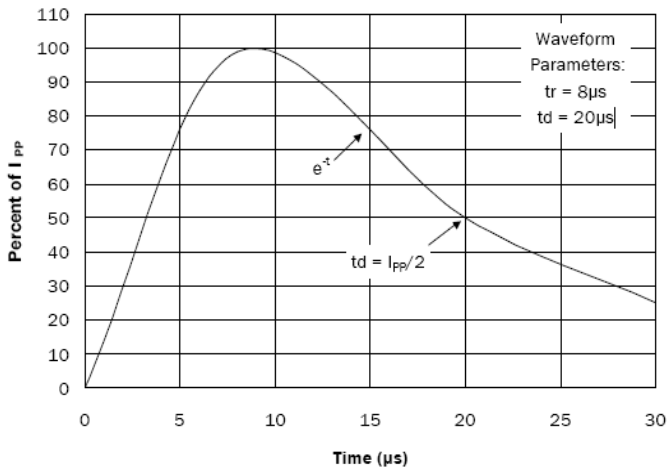


Power Derating Curve

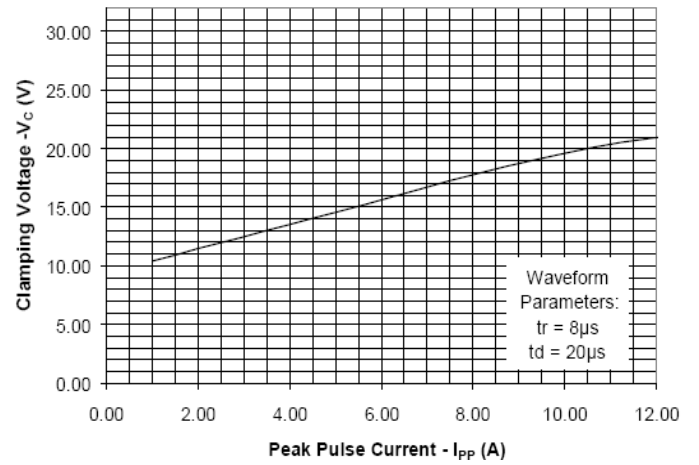


Low Capacitance TVS Diode Array

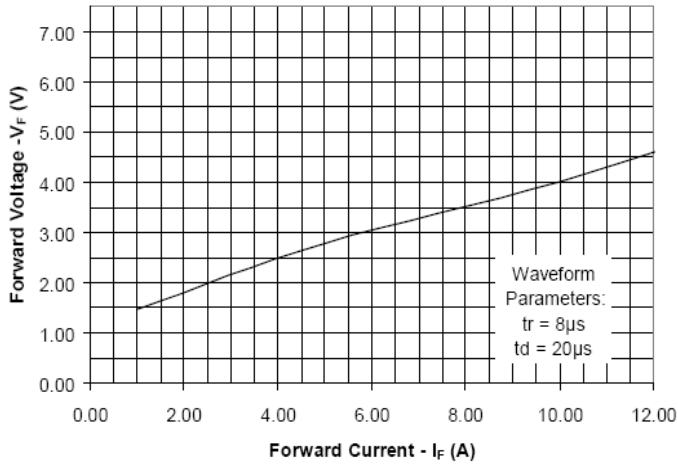
Pulse Waveform



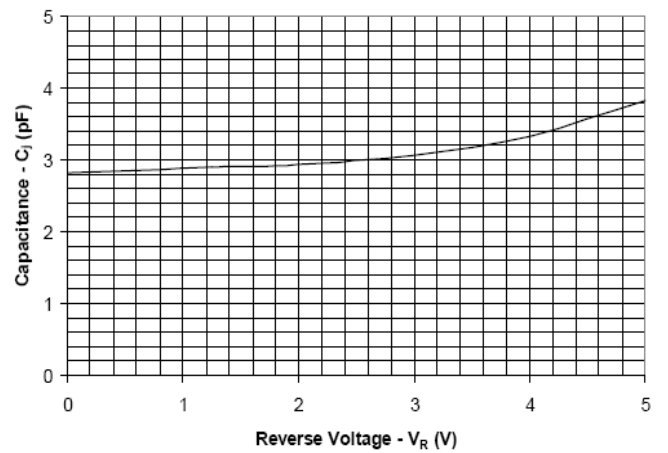
Clamping Voltage vs. Peak Pulse Current

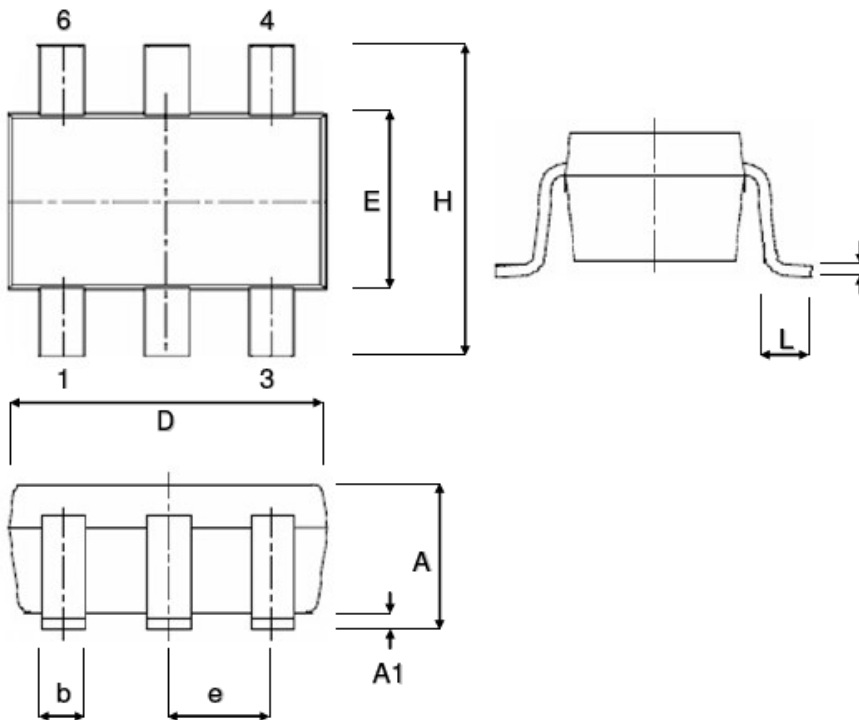


Forward Voltage vs. Forward Current



Capacitance vs. Reverse Voltage



PACKAGE OUTLINE & DIMENSIONS (SOT23-6L)


Symbol	Dimension in MM		Dimension in inch	
	Min.	Max.	Min.	Max.
A	1.05	1.35	0.041	0.053
A1	0.05	0.15	0.002	0.006
b	0.30	0.50	0.012	0.020
c	0.08	0.20	0.003	0.008
D	2.80	3.00	0.110	0.118
E	1.50	1.70	0.059	0.067
e	0.95 BSC		0.0374 BSC	
H	2.60	3.00	0.102	0.118
L	0.35	0.55	0.014	0.022